Application Data Sheet

Application Information

Application Type:: Regular

Subject Matter:: Utility

Suggested Group Art Unit:: N/A

CD-ROM or CD-R?:: None

Sequence submission?:: None

Computer Readable Form (CRF)?:: No

Title:: STRUCTURES AND METHODS FOR

INTERGRATION OF ULTRALOW-K

DIELECTRICS WITH IMPROVED

RELIABILITY

Attorney Docket Number:: 20140-00318-US

Request for Early Publication?:: No

Request for Non-Publication?:: No

Small Entity?:: No

Petition included?:: No

Secrecy Order in Parent Appl.?:: No

Applicant Information

Applicant Authority Type:: Inventor

Primary Citizenship Country:: US

Status:: Full Capacity

Given Name:: Stephen

Middle Name:: M.

Family Name:: Gates

Street of mailing address:: 22 Inningwood Rd.

City of mailing address:: Ossining

State or Province of mailing address:: New York

Postal or Zip code of mailing address 10562

Country of mailing address:: USA

Applicant Authority Type:: Inventor

Primary Citizenship Country:: US

Status:: Full Capacity

Given Name:: Son

Family Name:: Nguyen

Street of mailing address:: 16 Parkway Drive

City of mailing address:: Yorktown Heights

State or Province of mailing address:: New York

Postal or Zip code of mailing address 10598

Country of mailing address:: USA

Correspondence Information

Correspondence Customer Number:: 30678

Representative Information

Representative Customer Number:: 30678

Assignee Information

Assignee name:: International Business Machines

Corporation

Street of mailing address:: New Orchard Road

City of mailing address:: Armonk

State or Province of mailing address:: NY

Postal or Zip Code of mailing address:: 10504